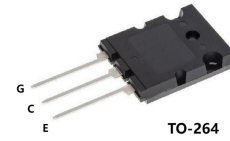


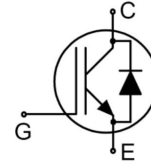
Features

- 1200V 50A, $V_{CE(sat)(typ.)}=2.8V$
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA



Applications

- Electric Welding Machine



Absolute Ratings ($T_c=25^{\circ}C$)

Parameter	Symbol		Value	Unit
Collector-Emitter Voltage	V _{CES}		1200	V
Collector Current-continuous	I _C	T=25℃	100	A
		T=100℃	50	A
Collector Current-pulse(note 1)	I _{CM}		200	A
Diode Continuous forward current	I _F	T=100℃	50	A
Diode Maximum Forward Current (Note 1)	I _{FM}		200	A
Gate-Emitter Voltage	V _{GES}		±30	V
Short Circuit Withstand Time	t _{SC}		10	us
Short Circuit Current	I _{SC}		350	A
Power Dissipation(Tc=25℃)	P _D	T _C =25℃	521	W
Power Dissipation(Tc=100℃)		T _C =100℃	104	W
Operating Temperature Range	T _J		-55~+150	℃
Storage Temperature Range	T _{STG}		-55~+150	℃
Maximum Lead Temperature for Soldering Purposes	T _L		260	℃

Electrical Characteristic($T_C=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Tests Conditions	Min	Typ	Max	Units
Off-Characteristics						
Collector-Emitter Voltage	BV_{CES}	$I_C=250\mu A, V_{GE}=0V$	1200	-	-	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V$	-	-	250	uA

Gate-body leakage current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 30V$	-	-	± 400	nA
On-Characteristics						
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}, I_C=250\mu A$	4.0	-	6.0	V
Collector-Emitter saturation Voltage	V_{CESAT}	$V_{GE}=15V, I_C=40A$	-	2.8	3.2	V
Dynamic Characteristics						
Input capacitance	C_{ies}	$V_{CE}=20V, V_{GE}=0V, f=1.0MHz, T_C=25^{\circ}C$	-	3000	-	pF
Output capacitance	C_{oes}		-	390	-	pF
Reverse transfer capacitance	C_{res}		-	230	-	pF
Total Gate Charge	Q_g	$V_{CE}=600V, I_C=50A, V_{GE}=15V, T_C=25^{\circ}C$	-	340	-	nC
Gate to emitter charge	Q_{ge}		-	27	-	
Gate to collector charge	Q_{gc}		-	210	-	
Switching Characteristics						
Turn-On delay time	$t_{d(on)}$	$V_{CC}=600V, I_C=50A, R_G=10\Omega, V_{GE}=15V$ Inductive load $T_C=25^{\circ}C$	-	13	-	ns
Turn-On rise time	t_r		-	28	-	ns
Turn-off delay time	$t_{d(off)}$		-	162	-	ns
Turn-off Fall time	t_f		-	36	-	ns
Turn-on switching loss	E_{on}		-	2.8	-	mJ
Turn-off switching loss	E_{off}		-	1.4	-	mJ
Anti-Parallel Diode Characteristics and Maximum Ratings						
Diode Forward Voltage	V_F	$V_{GE}=0V, I_F=50A.$	-	2.40	-	V
Diode Reverse recovery time	t_{rr}	$V_R=600V, I_F=40A$ $di_F/dt=500A/us$ $T_J=25^{\circ}C$	-	136	-	ns
Reverse recovery charge	Q_{rr}		-	1.5	-	μC
Diode Reverse recovery Current	I_{rrm}		-	11	-	A

Thermal Characteristics

Symbol	Parameter	Max	Units
$R_{th j-c}$	Thermal Resistance, Junction to case for IGBT	0.24	$^\circ C/W$
$R_{th j-c}$	Thermal Resistance, Junction to case for Diode	0.74	$^\circ C/W$
$R_{th j-a}$	Thermal Resistance, Junction to Ambient	25	$^\circ C/W$

Notes:

1: . Repetitive Rating: Pulse width limited by maximum junction temperature

Electrical Characteristics(curves)

Fig 1. DC Collector current as a function of case temperature ($V_{GE} \geq 15V$, $T_j \leq 150^\circ C$)

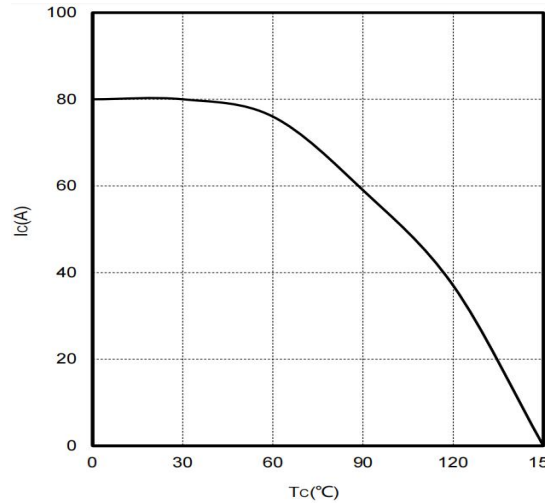


Fig 2. Power dissipation as a function of case temperature ($T_j \leq 150^\circ C$)

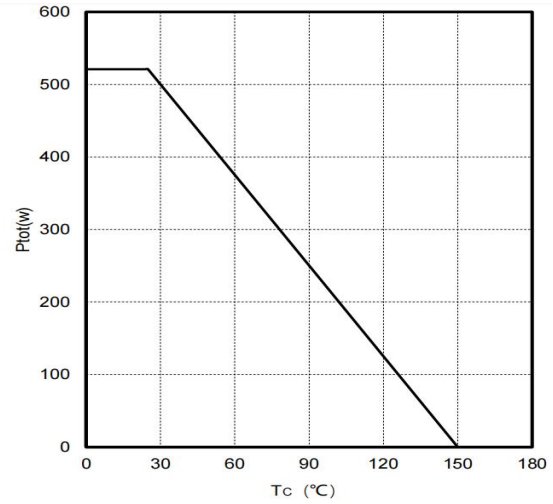


Fig 3. IGBT Forward safe operation area

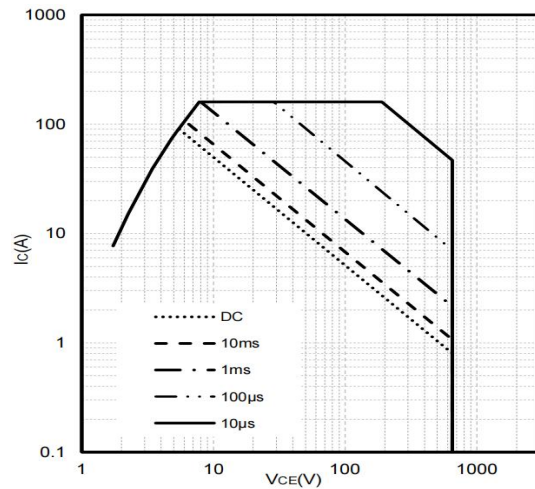


Fig 4. IGBT Reverse safe operation area

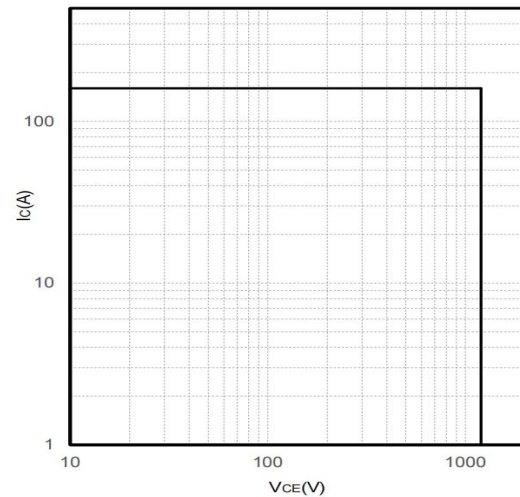


Fig 5. Typical output characteristic ($T_j = 25^\circ C$)

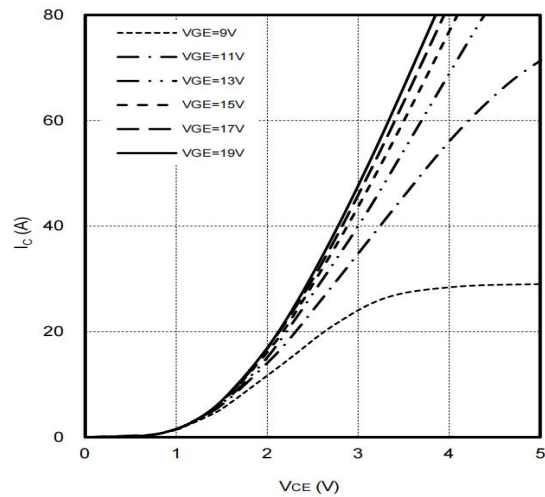


Fig 6. Typical output characteristic ($T_j = 125^\circ C$)

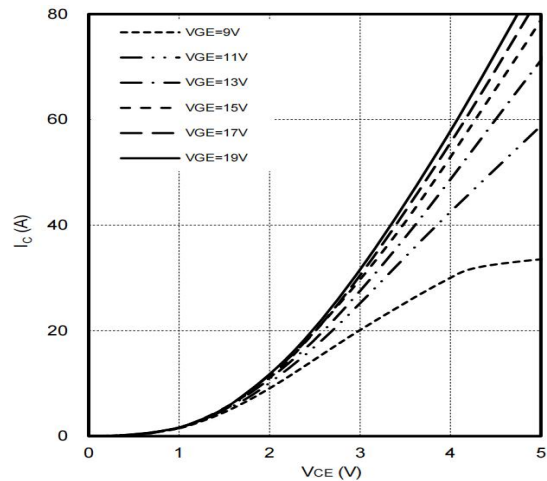


Fig 7. Transfer characteristic IGBT,
 $I_C = f(V_{GE})$, $V_{CE} = 20V$

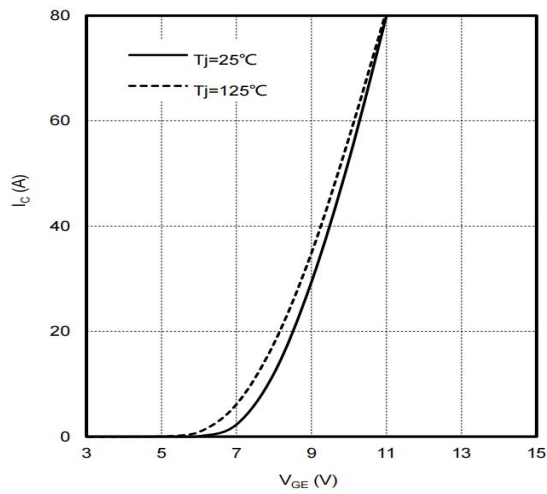


Fig 9. Typical collector-emitter saturation voltage as a function of V_{GE} ($T_J = 25^\circ C$)

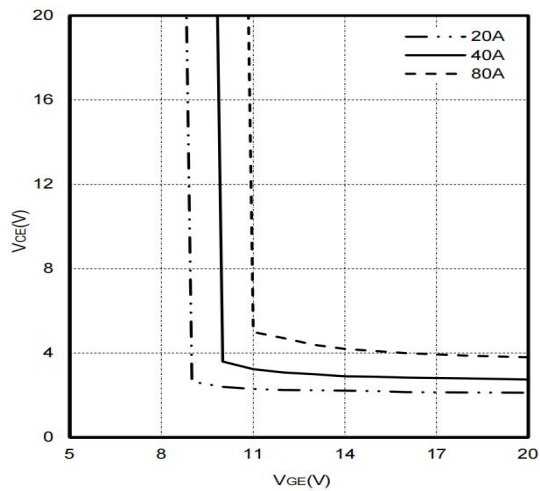


Fig 11. Typical switch energy as a function of I_C
(Inductive load, $T_J = 25^\circ C$, $V_{ce} = 600V$, $V_{ge} = 15V$, $R_g = 5\Omega$)

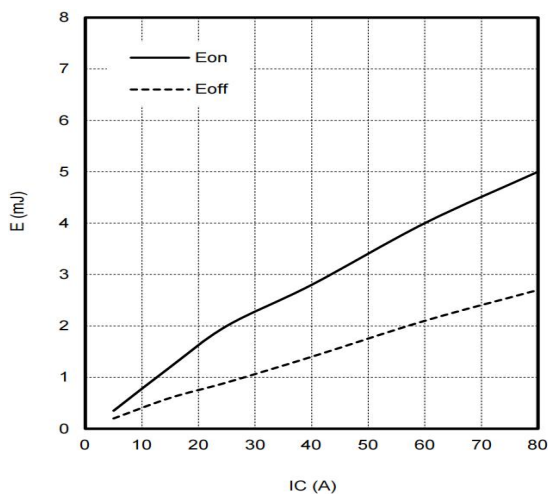


Fig 8. Typical collector-emitter saturation voltage
as a function of junction temperature,
 $IGBT V_{CEsat} = f(T_{vj})$, $V_{GE} = 15V$

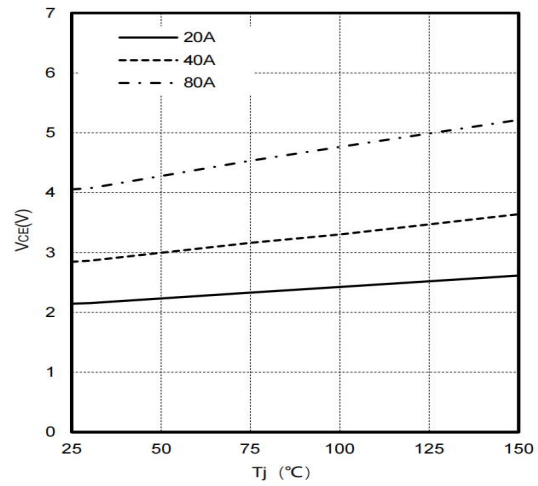


Fig 10. Typical collector-emitter saturation voltage as a function of V_{GE} ($T_J = 125^\circ C$)

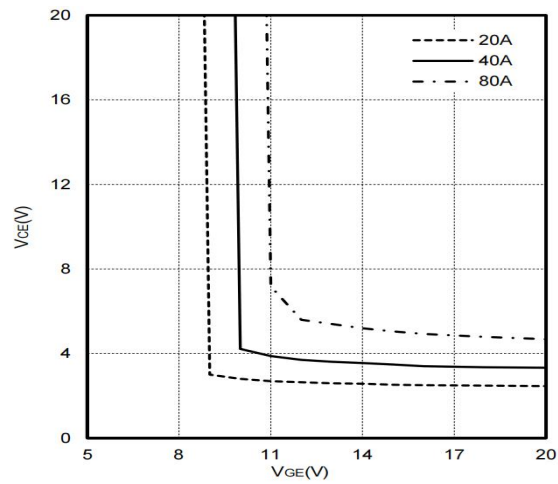


Fig 12. Typical switch time as a function of I_C
(Inductive load, $T_J = 25^\circ C$, $V_{ce} = 600V$, $V_{ge} = 15V$, $R_g = 5\Omega$)

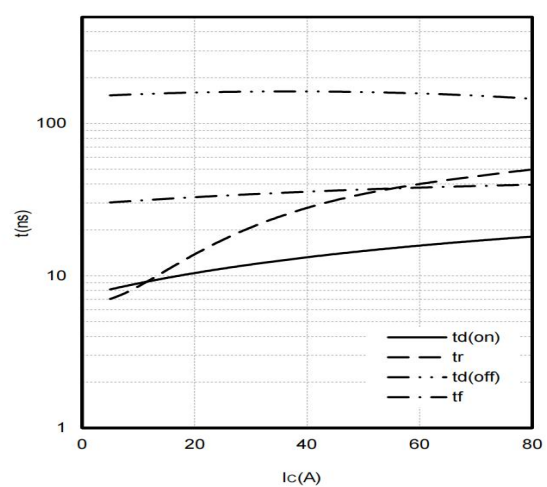


Fig 13. Typical switch energy as a function of R_g (inductive load, $T_j=25^\circ\text{C}$, $V_{ce}=600\text{V}$, $V_{ge}=15\text{V}$, $I_c=40\text{A}$)

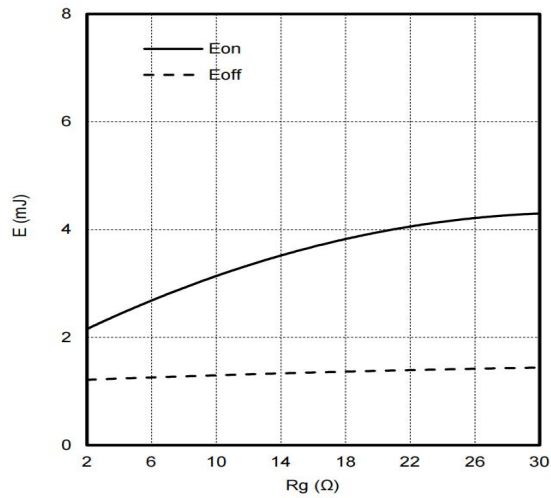


Fig 14. Typical switch time as a function of R_g (inductive load, $T_j=25^\circ\text{C}$, $V_{ce}=600\text{V}$, $V_{ge}=15\text{V}$, $I_c=40\text{A}$)

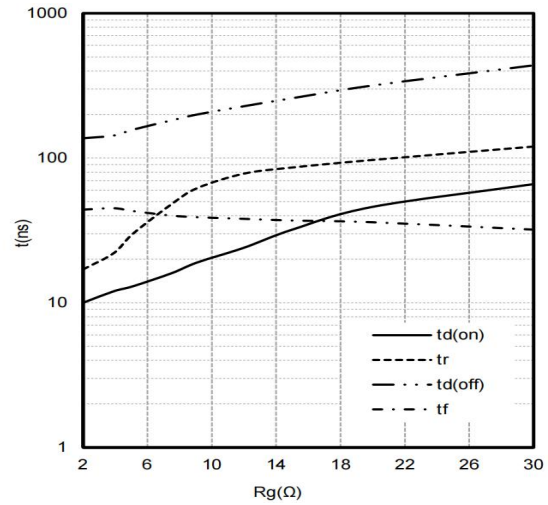


Fig 15. Typical capacitance as a function of collector-emitter voltage ($V_{ge}=0\text{V}$, $f=1\text{MHz}$)

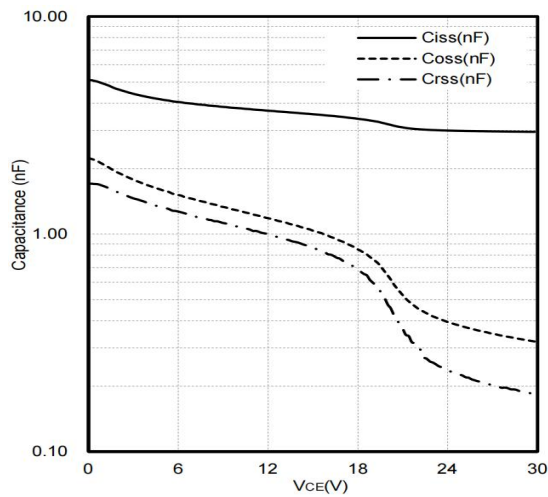


Fig 16. Typical gate charge ($I_c=40\text{A}$)

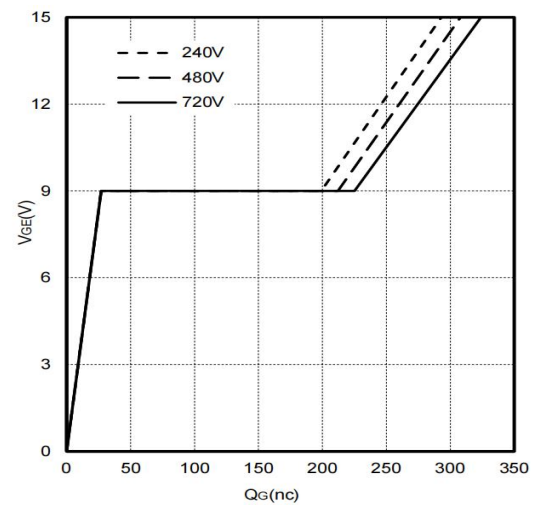


Fig 17. Typical diode forward current as a function of forward voltage

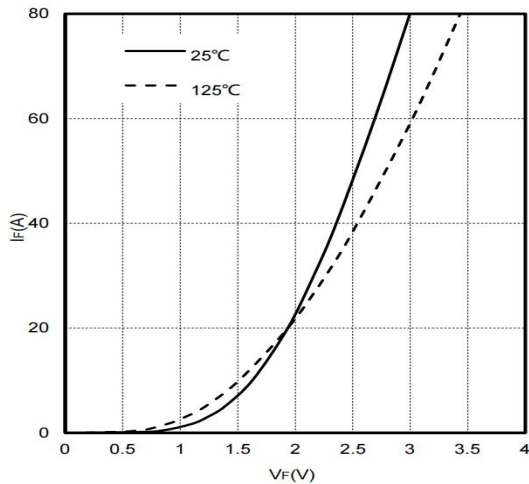


Fig 18. Typical trr as a function of di/dt , $V_r=600\text{V}$, $I_f=40\text{A}$, $T_j=25^\circ\text{C}$

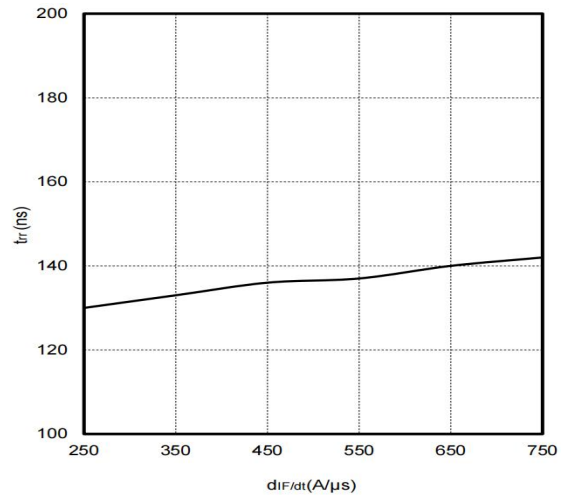


Fig 19. Typical I_{rrm} as a function of di/dt ,
 $V_r=600V$, $I_f=40A$, $T_j=25^\circ C$

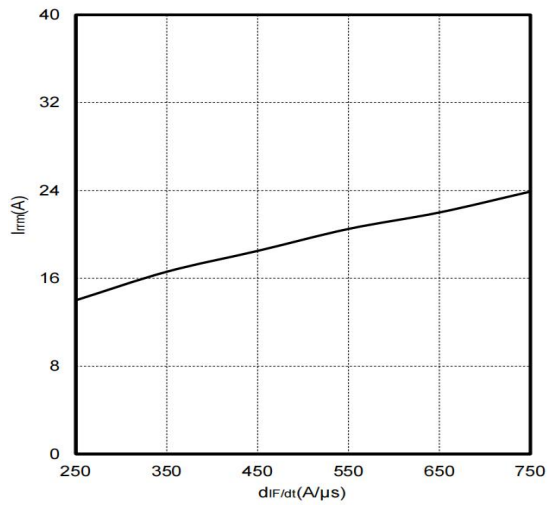


Fig 20. Typical Q_{rr} as a function of di/dt ,
 $V_r=600V$, $I_f=40A$, $T_j=25^\circ C$

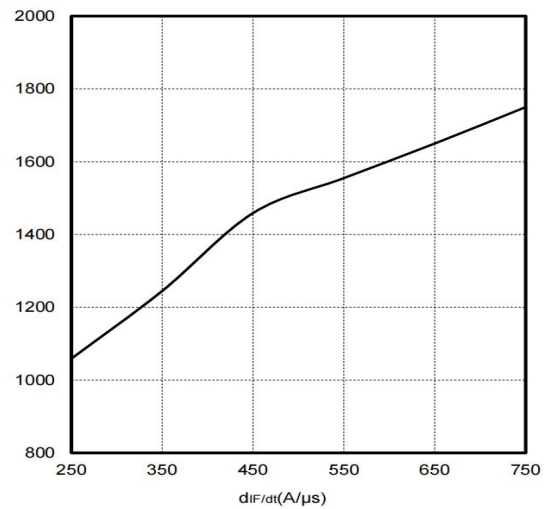
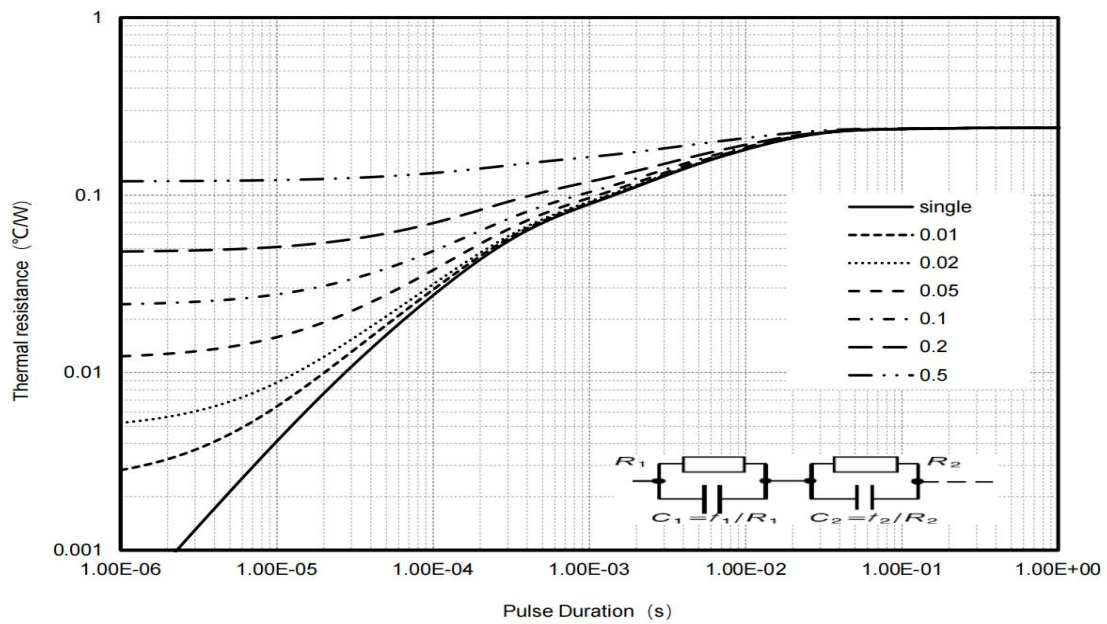
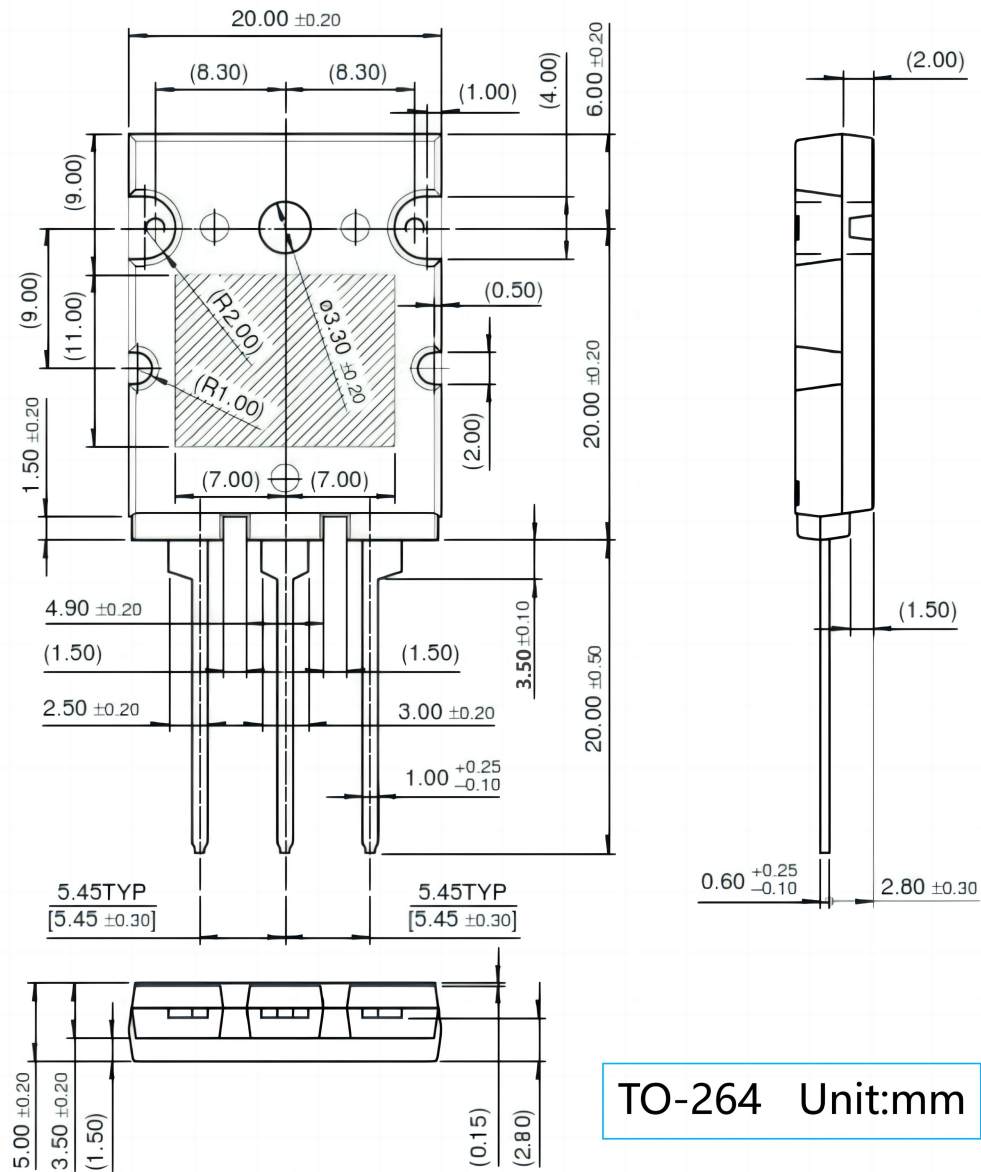


Fig 21. IGBT transient thermal impedance, $Z_{th}=f(t_p)$, $D=t_p/T$



Package Mechanical DATA



TO-264 Unit:mm